

NOTES:

- 1. REFERENCE PKG. DUTLINE: 21-0268.
- 2. LAND PATTERN COMPLIES TO: IPC7351A.
- 3. TOLERANCE: +/- 0.02 MM.
- 4. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND POFREE (+) PKG. CODES.
- 5. ALL DIMENSIONS IN MM.

-DRAWING NOT TO SCALE-

This document (including dimensions, notes & specs) is a recommendaton based on typical circuit board manufacturing parameters. Since land pattern design depend on many factors unknown to Maxim (eg. user's board manufacturing specs), user must determine suitability for use. This document is subject to change without notice.

Contact technical support at http://www.maxim-ic.com/support for further questions.



TITLE:

PACKAGE LAND PATTERN, [T1034N-1]

APPROVAL

DOCUMENT CONTROL NO. 90-0247

REV.

C /

REVISION HISTORY

A ECN #DS-09-0282 Initial release 05/28/09 GAUR B ECN #DS-09-0422 PKG. CODE CORRECTED TO: T1034N-1 08/11/09 GAUR	INATOR RI PATEL MM
B ECN #DS-09-0422 PKG. CODE CORRECTED TO: T1034N-1 08/11/09 GAUGE C ECN #DS-10-0046 CONTROLLING DIMENSIONS CHANGED TO MM - MINIMUM EXPOSED PAD 02/05/10	RI PATEL
C ECN #DS-10-0046 CONTROLLING DIMENSIONS CHANGED TO MM - MINIMUM EXPOSED PAD 02/05/10	
	ММ
TO COMPONENT LAND PAD CLEARANCE CHANGED TO 10 MILS	

MIXIM	TITLE: PACKAGE LAND PATTERN, [T1034N-1 / T1034N+1]		
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